

Chip 1

Requirements:

- Oxide Clad
- Use EBeam Library on KLayout, components include
 - GC_TE_1310_8degOxide_BB
 - Waveguide: 350nm x 220nm @ 1310nm
 - ebeam_splitter_swg_assist_te1310
- 1310nm wavelength
- FSR = 25GHz Spacing
- 605 x 410 um floorplan

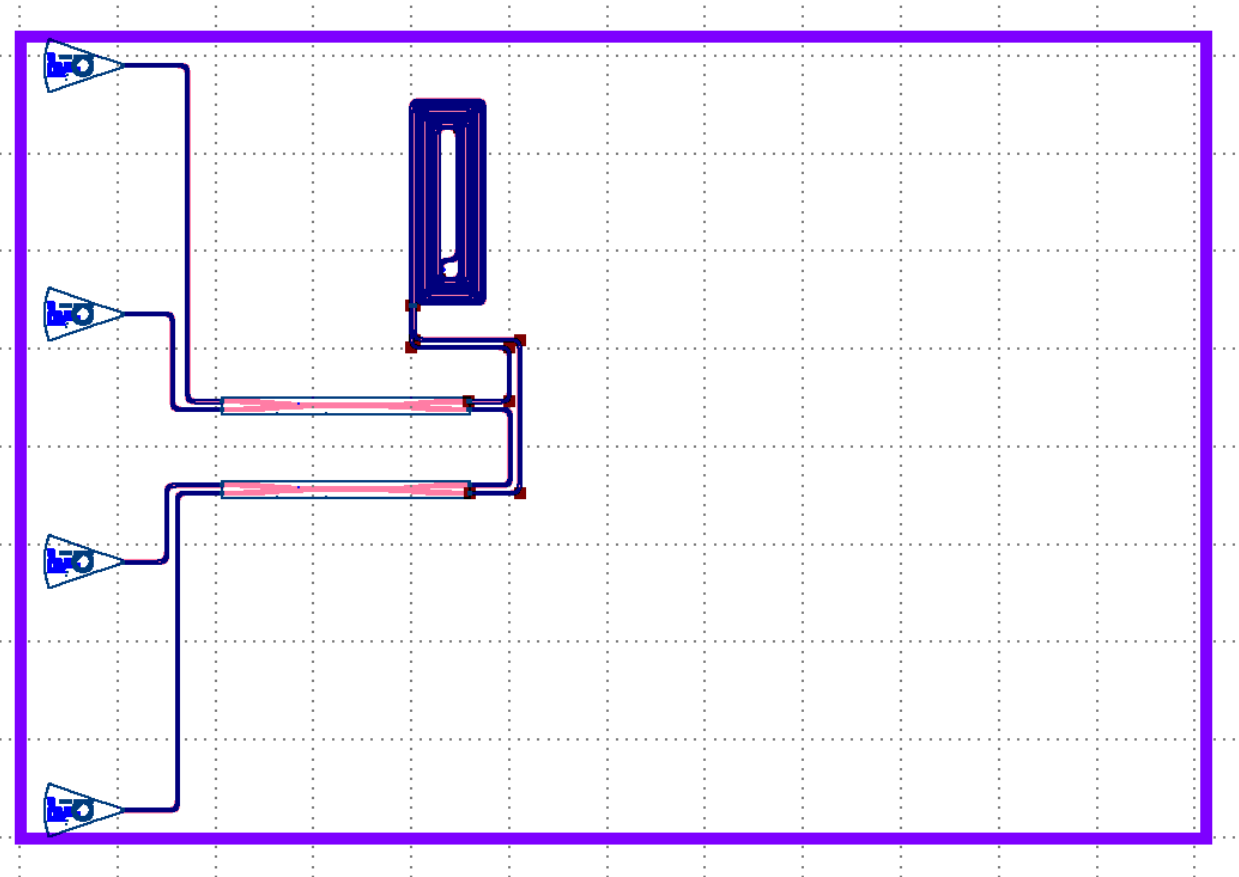
$$FSR = \frac{c}{n_g \Delta L}$$

Know FSR = 25GHz, $c = 3 \cdot 10^8$ m/s. Need to find n_g through simulation so that we can solve for the desired ΔL .

Know $\Delta L \approx 2.7mm$

wavelength (μm)	loss (dB/cm)	group index	
1.31	0.00069427	4.685088+3.373411e-09i	97
1.31	0.00067847	5.280983+5.911007e-09i	6
1.31	0.00015743	2.067760+2.796693e-09i	41

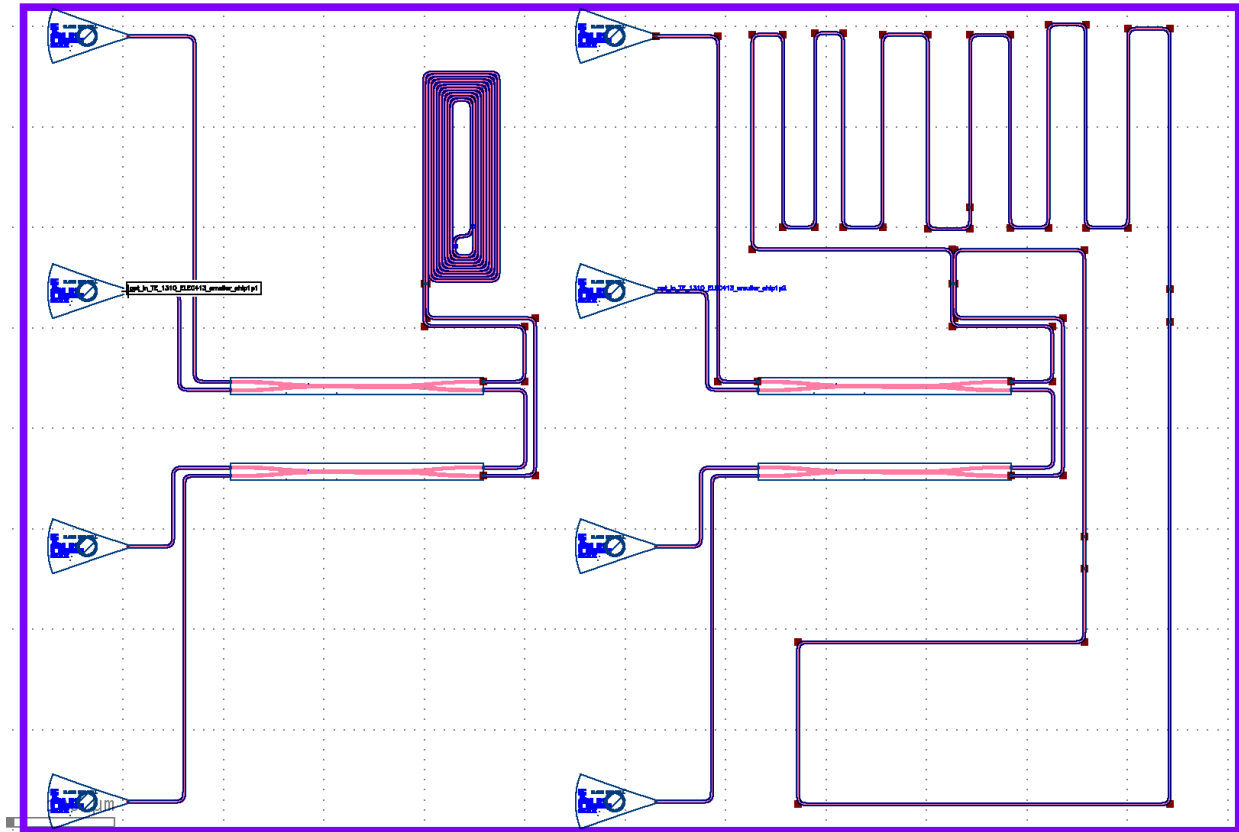
$$\Delta L = 2.65 \text{ mm}$$



L1 = 77.625

L2 = 2718.742

DL = 2641.118 = 2.641 mm 😊



For second setup:

$L1 = 77.625$

$L2 = 2747.32$

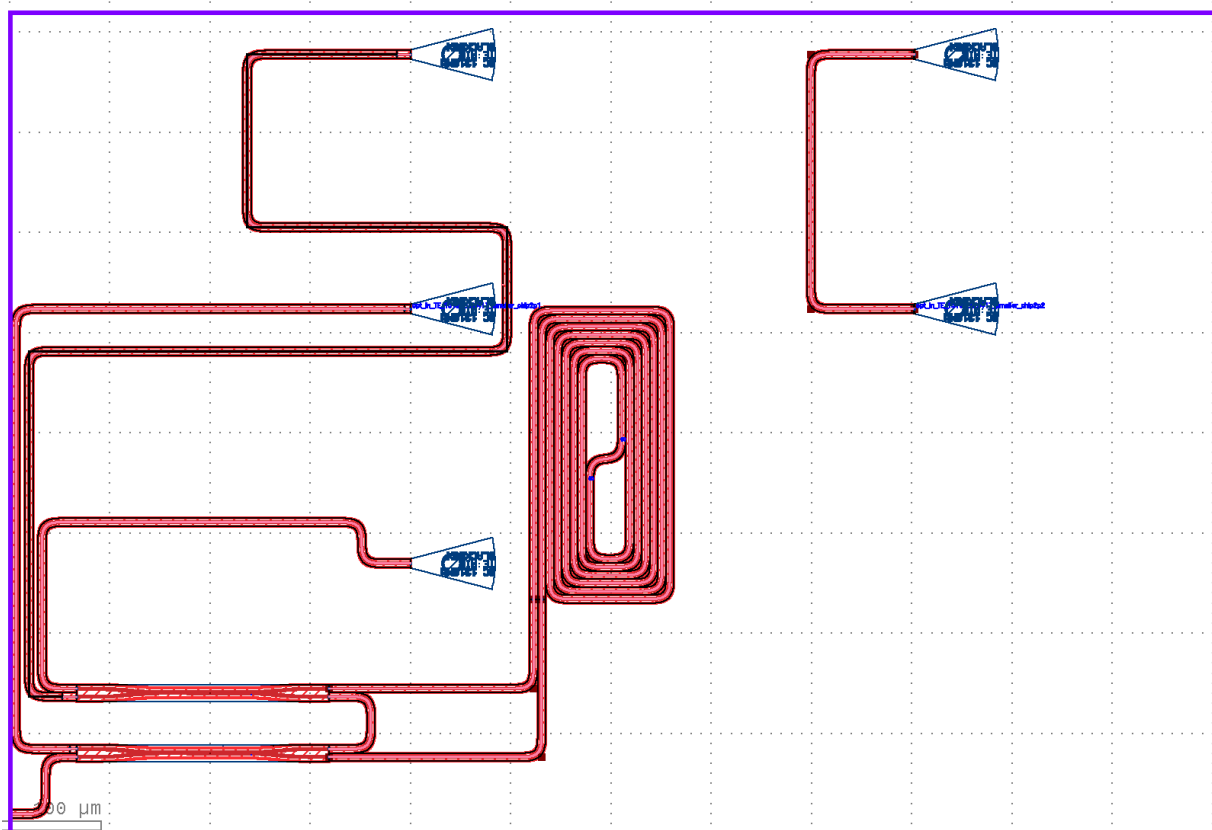
$DL = 2669.695 = 2.67\text{mm}$

Chip 2

Know $FSR = 25\text{GHz}$, $c = 3 \cdot 10^8 \text{ m/s}$. Need to find n_g through simulation so that we can solve for the desired ΔL .

$n_g = 4.88$

$DL = 2.469\text{mm}$



$L1 = 61.481$

$L2 = 2530.116$

$DL = 2468.635 = 2.468\text{mm}$